



ZHCS1000QTA

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

#### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F(TYP)</sub> @ 1A (V)	I <sub>R(TYP)</sub> @ V <sub>R</sub> =30V (μΑ)
40	1	0.425	50

#### **Features and Benefits**

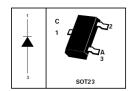
- High Current Capability ( $I_F = 1A$ )
- Low V<sub>F</sub>
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

# Applications

- DC-DC Converters
- Mobile Telecomms
- Blocking Diodes
- Reverse Polarity Protection

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 
  <sup>(63)</sup>
- Weight: 0.0089 grams (Approximate)



Top View

# Ordering Information (Note 5)

	Device	Compliance	Case	Packaging	
ZHCS1000QTA Automotive		SOT23	3000/Tape & Reel		
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.				

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

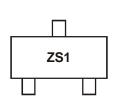
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

<1000ppm antimony compounds. 4. Automotive products are AEC-Q101 qualified and are PPAP capable. For more information, please refer to

http://www.diodes.com/product\_compliance\_definitions.html

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



ZS1 = Product Type Marking Code



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Continuous Reverse Voltage		V <sub>R</sub>	40	V
Average Rectified Output Current		lo	1	А
Forward Voltage @ I <sub>F</sub> = 1A (Typ)		V <sub>F</sub>	425	mV
Average Peak Forward Current; D.C. = 50%		I <sub>F(AV)</sub>	1750	mA
Non Repetitive Forward Current	t ≤ 100µs		12	А
Non Repetitive Forward Current	t ≤ 10ms	IFSM	5.2	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation, $T_A = +25^{\circ}C$	PD	500	mW
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

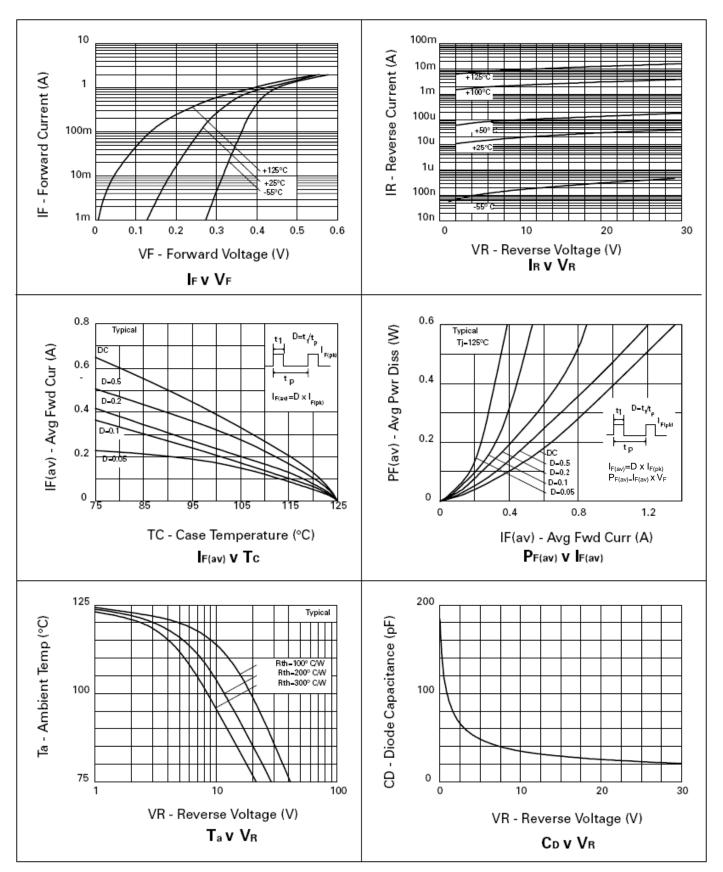
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V <sub>(BR)R</sub>	40	60	_	V	I <sub>R</sub> = 300μA
		_	240	270	- mV	$I_F = 50 \text{mA}$
		_	265	290		I <sub>F</sub> = 100mA
		_	305	340		$I_F = 250 \text{mA}$
Forward Voltage (Note 6)	N/	_	355	400		I <sub>F</sub> = 500mA
Folward Voltage (Note 6)	V <sub>F</sub>	_	390	450		I <sub>F</sub> = 750mA
		_	425	500		$I_F = 1A$
		_	495	600		I <sub>F</sub> = 1.5A
		_	420	_		$I_F = 1A, T_A = +100^{\circ}C$
Reverse Current (Note 7)	I <sub>R</sub>	_	50	100	μA	$V_R = 30V$
Total Capacitance	CT	_	25	_	pF	$f = 1MHz, V_R = 30V$
			12	_	ns	Switched from I <sub>F</sub> = 500mA to
Reverse Recovery Time	t <sub>RR</sub>	—				I <sub>R</sub> = 500mA
						Measured @ I <sub>R</sub> = 50mA

Notes:

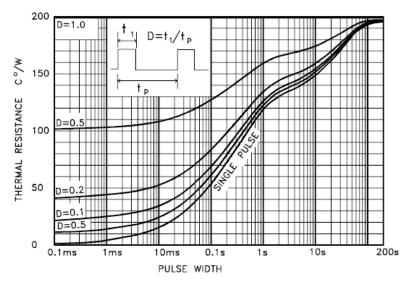
6. Measured under pulsed conditions. Pulse width =  $300\mu$ S. 7. Short duration pulse test used to minimize self-heating effect.





NEW PRODUCT





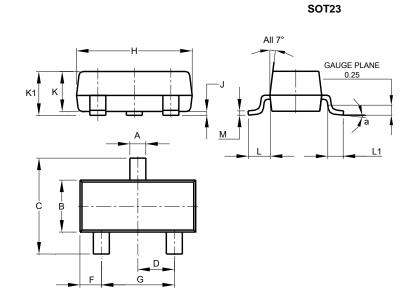
Maximum Transient Thermal Resistance\*

\* Devices were mounted on a 15mmx15mm ceramic substrate.



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

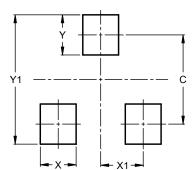


SOT23				
Dim	Min	Max	Тур	
Α	0.37	0.51	0.40	
В	1.20	1.40	1.30	
с	2.30	2.50	2.40	
D	0.89	1.03	0.915	
F	0.45	0.60	0.535	
G	1.78	2.05	1.83	
Н	2.80	3.00	2.90	
J	0.013	0.10	0.05	
ĸ	0.890	1.00	0.975	
K1	0.903	1.10	1.025	
L	0.45	0.61	0.55	
L1	0.25	0.55	0.40	
М	0.085	0.150	0.110	
а	0°	8°		
All Dimensions in mm				

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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